



N-CHANNEL ENHANCEMENT MODE FIELD MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
001/	3.0Ω @ V _{GS} = 10V	400mA
60V	4.0Ω @ V _{GS} = 5V	330mA

Features and Benefits

- N-Channel MOSFET
- Low On-Resistance
- Low Gate-Threshold Voltage
- Low-Input Capacitance
- Fast Switching Speed
- Small-Surface Mount Package
- ESD Protected Gate, 1.2kV HBM
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) yet maintain superior switching performance, which makes it ideal for high-efficiency power-management applications.

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
 Drivers: Relays, Solenoids, Lamps, Hammers, Displays,
 Memories, Transistors, etc.

Mechanical Data

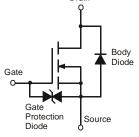
- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—NiPdAu over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.001 grams (Approximate)



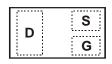
X1-DFN1006-3



Bottom View



Equivalent Circuit



Top View Pin Configuration

Ordering Information (Note 4)

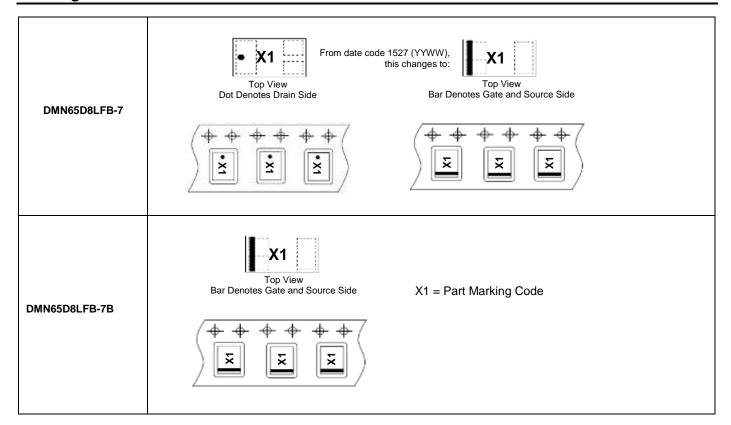
Part Number		Case	Packaging
	DMN65D8LFB-7	X1-DFN1006-3	3000/Tape & Reel
	DMN65D8LFB-7B	X1-DFN1006-3	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, refer to our website at http://www.diodes.com.



Marking Information





Maximum Ratings

Characteristic		Symbol	Value	Units	
Drain-Source Voltage			V_{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 4) V _{GS} = 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	260 210	mA
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	400 310	mA

Thermal Characteristics

Characteristic	Symbol	Value	Units
Power Dissipation, @ T _A = +25°C (Note 4)	P_{D}	430	mW
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 4)	$R_{\Theta JA}$	290	°C/W
Power Dissipation, @ T _A = +25°C (Note 5)	P_{D}	840	mW
Thermal Resistance, Junction to Ambient @ T _A = +25°C (Note 5)	Rejsa	147	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

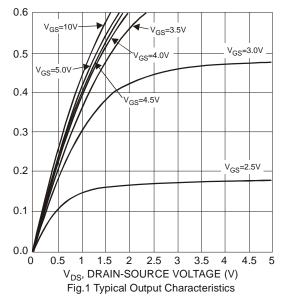
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

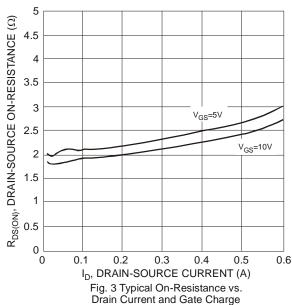
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	0.1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Body Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	1.2	_	2.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D			3.0	1 ()	$V_{GS} = 10V, I_D = 0.115A$	
Static Dialif-Source Off-Resistance	R _{DS (ON)}	_	_	4.0		$V_{GS} = 5V, I_D = 0.115A$	
Forward Transfer Admittance	Y _{fs}	80	320	_	mS	$V_{DS} = 10V, I_D = 0.115A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 0.115A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}	_	25	l	pF		
Output Capacitance	Coss	_	4.7	_	pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	Crss	_	2.5	_	pF		
Turn-On Delay Time	t _{D(on)}	_	3.27		ns		
Turn-On Rise Time	t _r	_	3.15	_	ns	$V_{DD} = 30V, V_{GEN} = 10V,$	
Turn-Off Delay Time	t _{D(off)}	_	12.025	_	ns	$R_{GEN} = 25\Omega, I_D = 0.115A$	
Turn-Off Fall Time	tf	_	6.29	_	ns		

Notes:

- Device mounted on FR-4 PCB with minimum recommended pad layout, single-sided.
 Device mounted on 2" x 2" FR-4 PCB with high coverage 2oz. Copper, single-sided.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.







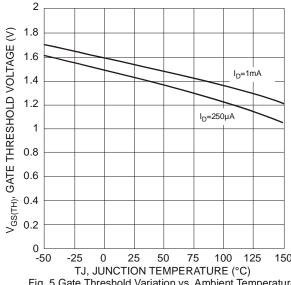
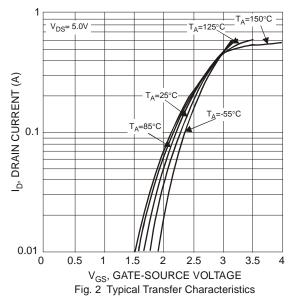
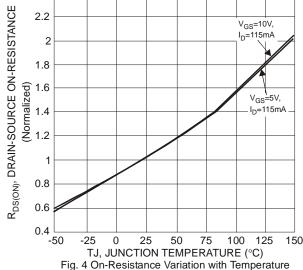


Fig. 5 Gate Threshold Variation vs. Ambient Temperature

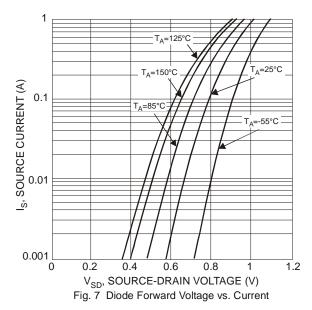


2.4



50 f=1MHz 45 C_T, JUNCTION CAPACITANCE (pF) 40 35 30 C_{ISS} 25 20 15 10 $\mathbf{c}_{\mathrm{oss}}$ 5 C_{RSS} 0 25 0 15 V_{DS} , DRAIN-SOURCE VOLTAGE Fig. 6 Typical Junction Capacitance

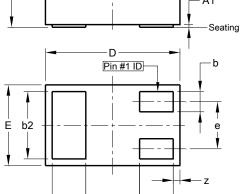




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

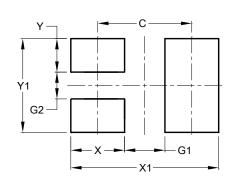
A1 Seating Plane



X1-DFN1006-3						
Dim	Min	Max	Тур			
Α	0.47	0.53	0.50			
A1	0.00	0.05	0.03			
b	0.10	0.20	0.15			
b2	0.45	0.55	0.50			
D	0.95	1.075	1.00			
Е	0.55	0.675	0.60			
е	-	-	0.35			
L1	0.20	0.30	0.25			
L2	0.20	0.30	0.25			
L3	-	-	0.40			
Z	0.02	0.08	0.05			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X1-DFN1006-3

X1-DFN1006-3

Dimensions	Value (in mm)		
С	0.70		
G1	0.30		
G2	0.20		
Х	0.40		
X1	1.10		
Y	0.25		
Y1	0.70		



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